# APPLICATION OF RESPONSE SURFACE METHODOLOGY IN OPTIMIZING ELECTROPLATING PARAMETERS OF NICKEL INTERLAYER ON TUNGSTEN CARBIDE

## MOHD ZULKHAAIRI BIN TUKIMIN

A thesis submitted in fulfilment of the requirements for the award of the degree of Master of (Mechanical Engineering)

Faculty of Mechanical Engineering
Universiti Teknologi Malaysia

Dedicated to my family and beloved wife

## **ACKNOWLEDGEMENTS**

I would like to thank to Allah Almighty for blessing and strength given to accomplish this thesis. A special thank and sincere gratitude to my supervisor, Professor Dr. Noordin Bin Mohd Yusof for their great assistance, lesson, contribution and valuable guidance through this research where I never forget. To Associate Professor Dr. Izman Bin Sudin, thank for being co-supervisor with giving me opportunity and encouragement in every way I need in this research.

The acknowledgement also addressed to technician in Production Laboratory, Material Science and Metrology Laboratory for their continuous assist and cooperation in the various task. To my fellow friend, researchers and colleagues in Universiti Teknologi Malaysia, thank for your support, advice and make my daily life more colorful.

Deepest gratitude to my parents, family and my beloved wife who give me a real support in any respect together with pray and continuous encouragement for this research. I dedicate this thesis to all of them.

#### **ABSTRACT**

Tungsten carbide (WC-Co) is categorized as a high wear resistance and fracture toughness material. But, these tool materials are found to wear rapidly when machining some particular workpieces. Various techniques have been proposed to improve the WC-Co performance. One such technique is by diamond coating WC-Co. This was done due to its outstanding mechanical properties. Poor adhesion of the coating onto the substrate is the main technical barrier. This is due to the presence of cobalt in the cemented carbide which produces graphite layer. Pre-treatment step is always needed because the nucleation of specific coating is greatly affected by the initial surface conditions of the substrate. In this study, nickel was used as an interlayer and the Watt bath electroplating technique was employed to deposit a thin layer with good adhesion strength. Effect of electroplating parameters such as current density, bath temperature and surface roughness of substrate were studied. Coating thickness, hardness and surface morphology were investigated according to an experimental plan. Subsequently, full factorial experimental design followed by analysis of variance (ANOVA) were applied to analyze the statistical data. Performances of the nickel coating on the WC-Co substrate were analyzed and evaluated using Response Surface Methodology (RSM). The electrodeposition parameters have a great influence on Ni coatings properties. One can observe that lower current density produced more compact morphology and fined grain size. Increase in the thickness of Ni coatings occurred by increasing current density. Comparatively, bath temperature did not have a notable effect on coatings thickness but had great influence on surface morphology and adhesion strength of coatings. Further observation on nickel deposition found that, current density  $\approx 4$  to 5 A/dm<sup>2</sup>, bath temperature  $\leq 60^{\circ}$ C and surface roughness  $\geq 0.5 \mu m$  have apparent effects on excellent quality of Ni coatings on tungsten carbide especially in producing a thin layer of coating.

#### **ABSTRAK**

Tungsten Karbida (WC-Co) dikategorikan sebagai bahan yang mempunyai rintangan kehausan dan tahap keliatan yang tinggi. Akan tetapi, bahan ini dikenalpasti akan mengalami kehausan dengan cepat apabila proses pemesinan dijalankan terhadap sesuatu benda kerja. Pelbagai kaedah telah diperkenalkan untuk meningkatkan prestasi dan sifat WC-Co itu sendiri. Salah satu kaedah yang digunakan adalah seperti saduran berlian. Saduran pada substrat yang mempunyai kelekatan yang rendah merupakan halangan teknikal utama disebabkan oleh kehadiran kobalt dalam WC-Co yang menghasilkan lapisan grafit. Rawatan awal sebelum proses saduran sentiasa diperlukan kerana memberikan kesan yang besar terhadap keadaan permukaan substrat. Dalam kajian ini, nikel bertindak sebagai lapisan antara dan teknik elektropenyaduran takungan Watt telah diaplikasikan untuk menghasilkan lapisan nipis dengan kekuatan lekatan yang baik. Kesan parameter elektropenyaduran seperti kepadatan arus, suhu larutan dan kekasaran permukaan substrat telah dikaji. Ketebalan dan kekuatan saduran serta morfologi permukaan dikaji dengan merujuk kepada pelan ujikaji. Kaedah rekabentuk ujikaji berfaktor penuh diikuti dengan analisis varians (ANOVA) telah digunakan untuk menilai data statistik yang diperolehi. Prestasi saduran nikel terhadap WC-Co telah dianalisis dan dinilai menggunakan kaedah tindak balas permukaan (RSM). Keputusan menunjukkan parameter saduran elektro mempunyai pengaruh yang besar terhadap sifat salutan Ni. Kepadatan arus yang rendah telah menghasilkan morfologi yang lebih padat dan ketebalan pada saduran Ni bertambah dengan peningkatan kepadatan arus. Suhu larutan tidak memberi kesan ketara terhadap ketebalan saduran tetapi memberikan kesan yang besar kepada kekuatan saduran dan juga morfologi permukaan. Didapati juga bahawa kepadatan arus ≈4 hingga 5 A/dm², suhu larutan ≤60 °C dan kekasaran permukaan ≥0.5 µm memberikan kualiti yang terbaik kepada saduran Ni ke atas WC-Co untuk menghasilkan lapisan nipis.

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## LIST OF SYMBOLS

SEM - Scanning Electron Microscopy

FESEM - Field Emission Scanning Electron Microscopy

ANOVA - Analysis of Variance

RSM - Response Surface Methodology

CCD - Central Composite Design

BWT - Blast Wear Tester

R<sup>2</sup> - Coefficient of determination

Pred. R<sup>2</sup> - Predicted R – square

Adj. R<sup>2</sup> - Adjusted R- square

Adeq. precision - Adequate precision

CD - Current density

T - Temperature

SR - Surface roughness

Y - Response (thickness)

H - Response (hardness)

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## **CHAPTER 1**

## INTRODUCTION

## 1.1 Background

The cemented tungsten carbide cutting tools are used widely in the machining, mining and stone cutting industry. However, these tools are found to wear rapidly when machining some particular materials such as abrasive composites or high silicon-filled aluminum. Numerous research studies (Ma *et al.* 2007, Polini *et al.* 2006, Polini and Barletta, 2008) showed that efficient and energy saving cutting tools is required to reduce the tool's down-time, increase cutting productivity and improve the quality of the machined surface. Moreover, diamond coating has been proposed to improve the performance of cemented carbide tools due to its outstanding mechanical properties. Along with great wear resistance, the advantages of the diamond coating include high surface hardness, high thermal conductivity, reduced friction, better corrosion protection, and improved optical properties (Polini, 2006, Xu *et al.* 2007).

Diamond film deposition has thus made it possible to use many diamond properties in new and innovative applications. Surprisingly, simple procedures for producing low-pressure diamond films now means thin films can be obtained on wear components having complex geometries. Polini (2006) reported that the ultimate goal of using CVD diamond coatings is to extend the technical performance of components, such as tools, beyond their conventional wear life. CVD diamond films are highly resistant to chemical and abrasive wear (Kamiya *et al.* 2002). Moreover diamond-coated articles are of little use if these deposits do not remain attached to the underlying substrate during use. Consequently, in the case of CVD diamond coated articles it is mandatory to optimize both adhesion and wear resistance.

The application of diamond coatings to enhance the overall machining effectiveness of WC-Co by reducing the tools downtime; increasing the cutting productivity and improving the quality of the machined surface are becoming more attractive. Polycrystalline diamond (PCD) tools on a WC-Co substrate were generally used for this purpose. Therefore, because of their high cost, many researchers and industrial users are instead using diamond films deposited using CVD techniques which are relatively inexpensive, and could be deposited on tools of any geometry. Compared to an uncoated cemented carbide tool, the CVD diamond coated tool shows much greater abrasive wear resistance which results in up to ten times longer tool life, and less build-up edge and lower cutting forces which yield a better surface finish on the workpiece materials. Besides, one of the largest barriers to be overcome is the poor adhesion of diamond film on the cemented carbides substrate. This is due to (i) the large thermal mismatch of the diamond film with the cemented carbide tool and (ii) weak interface bonding resulting from graphite film formation during low-pressure diamond deposition due to the presence of the cobalt binder. There are many reports, which claimed to reduce the thermal mismatch and to limit the graphite formation by etching cobalt (Sarangi et al. 2008, Polinia et al. 2002, Sahoo et al. 2002) and/or depositing interlayer as diffusion barriers.

Due to excellent wetting ability, tungsten carbide with cobalt has made this metal the first choice as binder. However, high cost and environmental pollution impacts are basically the main issue for cobalt usage. Substitution of cobalt with other metals has always been figured out. Some other metals that have been used as binder are iron, nickel and manganese. In addition to lower cost, nickel has higher corrosion resistance than cobalt.

Among the various manufacturing methods, electroplating has received considerable attention as a feasible, inexpensive and economically viable processing technique for producing thin layer (Rashidi and Ahmadeh, 2010, Ewecharoen *et al.* 2008). Consequently, especially nickel layer, prepared by electrodeposition has high density, minimum porosity, excellent corrosion resistance and good wear resistance and as the grain size of nickel is reduced, the strength and strain hardening rate also increased (Pan *et al.* 2007, Molloy *et al.* 2011).

Performance of nickel electrodeposits is related with their microstructure (such as grain size, surface morphology and crystal orientation), which depended on electroplating conditions (such as, current density, current efficiency and time) and composition of plating bath. Xuetao et al. (2008) studied the influence of pulse ontime, off-time, peak current density and saccharin on the grain size, surface morphology, crystal orientation, and microhardness. Furthermore, substrate roughness is one of the electrodeposition parameter that is sometimes difficult to control as well as important in terms of quality and functionality. Vitry et al. (2010) indicated that mechanical preparation (such as grinding) may be difficult to implement because of the complicated geometries but also proved that surface roughness can affect the coating appearance. The effect of surface roughness on nickel characteristics was investigated by Bulasara et al. (2011) who found that surface roughness did not contribute much to the performance characteristics of plating efficiency and thickness. Boonyongmaneerat et al. (2009) noticed that current density is one of the processing parameters that controls the microstructure and hence the apparent hardness of the composite. In additional, micro-hardness and surface morphology of a nickel coating were hardly influenced by getting optimum setup parameters for electrodeposition. Ranjan *et al.* (2011a) found that microhardness of the nano-composite of nickel coating increases with the increase in the stirring rate up to 450 rpm.

#### 1.2 Problem Statement

Poor adhesion of diamond coating is the main technical barrier for commercialization of diamond-coated tools. During high temperature diamond deposition process, the presence of cobalt in cemented carbide suppresses diamond growth. Co leaching from the WC–Co substrate catalyzes the formation of non-diamond carbon (sp<sup>2</sup> bonded), instead of sp<sup>3</sup> bonded diamond. The weak graphite layer at the interface results in poor adhesion between the diamond coating and the substrate.

Removing the Co binder from the substrate using Murakami reagent and acid etching is usually conducted to grow adhered diamond coatings. However, the substrate's mechanical properties and toughness are significantly reduced after etching. Etching WC grains with Murakami solution desirably increases the substrate surface roughness substantially but also causes increase in the surface Co content. It can be realized that substantial surface roughness with low cobalt content is the most desirable surface for deposition of diamond film. A large amount of residual stress will be produced due to mismatch of the coefficient of thermal expansion (CTE). The film could easily delaminate from the substrate right after deposition. Diffusion barriers (interlayer) such as Cu, Cr, Ni, Ti-based layer and CrN have been developed to prevent the Co catalyst effect but the hardness and other interlayer properties still needs to be improved.

It has been observed that mechanical interlocking effect caused by a rough surface can contribute significantly to improve hardness and adhesion of interlayer. Enhancement of surface roughness through interlayer surface is beneficial in that the nickel can well-retained in the cavity and improve hardness and provide well anchored roots for subsequently grown of nickel layer. There is however lacking of experimental information regarding the nickel properties when being deployed as an interlayer. Also, mathematical models for various interlayer responses are also not available. The availability of such model will enable the determination of optimal process condition.

## 1.3 Objectives of the Research

The objectives of this research are as follows:

- 1. To evaluate the various nickel coating properties obtained when using different nickel electroplating parameters on tungsten carbide, WC-6%-Co substrate.
- 2. To develop mathematical models and provide experimental evidences for predicting various nickel coatings properties.
- 3. To optimize the condition of nickel electroplating parameters in terms of current density, bath temperature and surface roughness of substrate to achieve high quality of nickel coating properties based on the Design of Experiment models.

## 1.4 Scope of the Research

This study was limited to the following:

- 1. Tungsten carbide, WC-6% Co with diameter 12mm was used as substrate and electroplating technique was employed for deposition purpose.
- 2. Electroplating parameters were studied include current density, bath temperature and surface roughness of substrate and for the whole deposition process, pH value of nickel solution was kept constant at 4.
- 3. Response variables evaluated include coating hardness, thickness and surface morphology.

# 1.5 Significance of the Research

This study focuses on obtaining on effective nickel interlayer on tungsten carbide substrate using suitable electroplating parameters. The suitability of the interlayer was evaluated in terms of the coating hardness and thickness. Additionally, suitable empirical models were developed using the experimental data for describing the relationship between the various responses and the related factors. With the completion of this research, the viability of using the electroplating process as an alternative process for obtaining the interlayer can be produced. The mathematical models obtained will facilitate the determination of the suitable process setting as well as the prediction of the responses investigated.

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